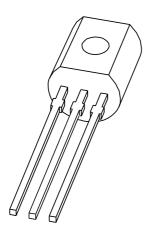
DISCRETE SEMICONDUCTORS

DATA SHEET



BC517NPN Darlington transistor

Product specification Supersedes data of 2003 Oct 16 2004 Nov 05





NPN Darlington transistor

BC517

FEATURES

- High current (max. 500 mA)
- Low voltage (max. 30 V)
- Very high DC current gain (min. 30000).

APPLICATIONS

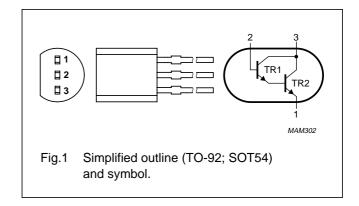
· Where very high amplification is required.

DESCRIPTION

NPN Darlington transistor in a TO-92; SOT54 plastic package. PNP complement: BC516.

PINNING

PIN	DESCRIPTION
1	emitter
2	base
3	collector



ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
I THE NOWIBER	NAME	DESCRIPTION	VERSION		
BC517	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54		

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter		40	V
V _{CES}	collector-emitter voltage	V _{BE} = 0 V	_	30	V
V _{EBO}	emitter-base voltage	open collector	_	10	V
I _C	collector current (DC)		_	500	mA
I _{CM}	peak collector current		_	800	mA
I _B	base current (DC)		-	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	625	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

Philips Semiconductors Product specification

NPN Darlington transistor

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	200	K/W

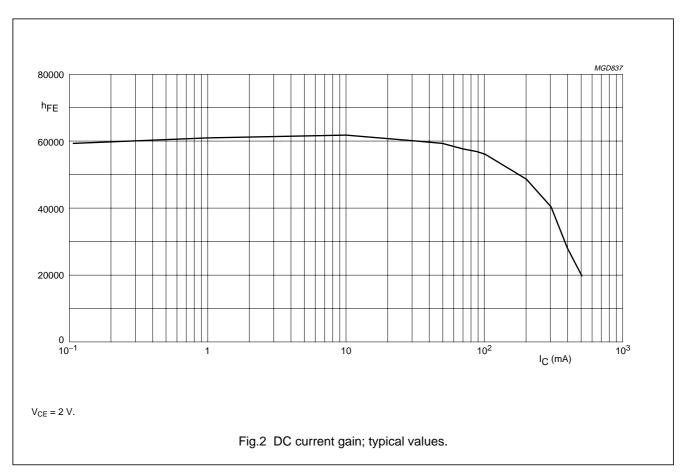
Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	PARAMETER CONDITIONS			MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 30 V; I _E = 0 A	_	_	100	nA
I _{EBO}	emitter-base cut-off current	V _{EB} = 10 V; I _C = 0 A	_	_	100	nA
h _{FE}	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 20 \text{ mA}; \text{ see Fig.2}$	30000	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 100 mA; I _B = 0.1 mA	_	_	1	٧
V _{BEsat}	base-emitter saturation voltage	$I_C = 100 \text{ mA}; I_B = 0.1 \text{ mA}$	_	_	1.5	٧
V _{BEon}	base-emitter on-state voltage	V _{CE} = 5 V; I _C = 10 mA	_	_	1.4	٧
f _T	transition frequency	$V_{CE} = 5 \text{ V; } I_{C} = 30 \text{ mA;}$ f = 100 MHz	_	220	_	MHz



Philips Semiconductors Product specification

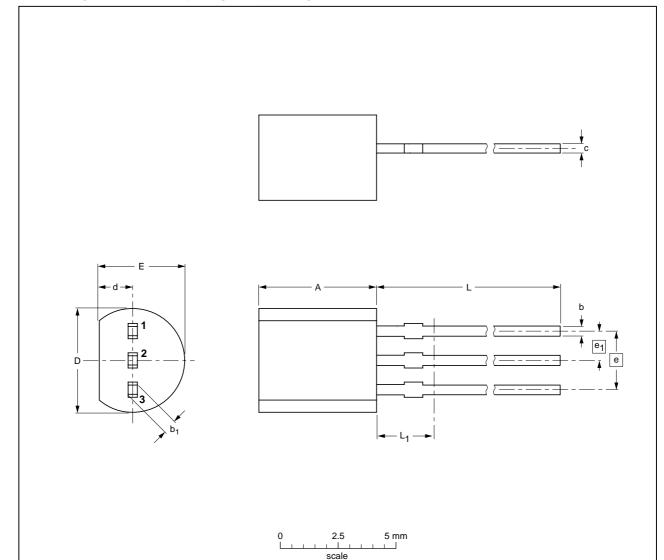
NPN Darlington transistor

BC517

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	Α	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE	OUTLINE REFERENCES					ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	
SOT54		TO-92	SC-43A			97-02-28 04-06-28

Philips Semiconductors Product specification

NPN Darlington transistor

BC517

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

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- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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